



Glass passivated rectifier

Features

1. Glass passivated die construction
2. Ideal for surface mounted applications
3. Low leakage current
4. Voltage range 50 to 1000 volts
5. High reliability



Applications

General-purpose rectification

Absolute Maximum Ratings

$T_j=25^\circ\text{C}$

Parameter	Test Conditions	Type	Symbol	Value	Unit
Repetitive peak reverse voltage =Working peak reverse voltage =DC blocking voltage		SM4001	V_{RRM}	50	V
		SM4002	$= V_{RWM}$	100	V
		SM4003	$= V_R$	200	V
		SM4004		400	V
		SM4005		600	V
		SM4006		800	V
		SM4007		1000	V
Peak forward surge current			I_{FSM}	30	A
Average forward current	$T_A=75^\circ\text{C}$		I_{FAV}	1	A
Junction temperature			T_j	-65~+175	$^\circ\text{C}$
Storage temperature range			T_{stg}	-65~+175	$^\circ\text{C}$

Electrical Characteristics

$T_j=25^\circ\text{C}$

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Forward voltage	$I_F=1\text{A}$	V_F			1.1	V
Maximum full load reverse current, full cycle average	$T_A=75^\circ\text{C}$				30	$\mu\text{ A}$
Maximum DC average reverse Current at DC blocking voltage	$T_A=25^\circ\text{C}$	I_R			5	$\mu\text{ A}$
	$T_A=125^\circ\text{C}$				50	$\mu\text{ A}$
Typical junction capacitance	$V_R=4\text{V}, f=1\text{MHz}$	C_J		15		pF

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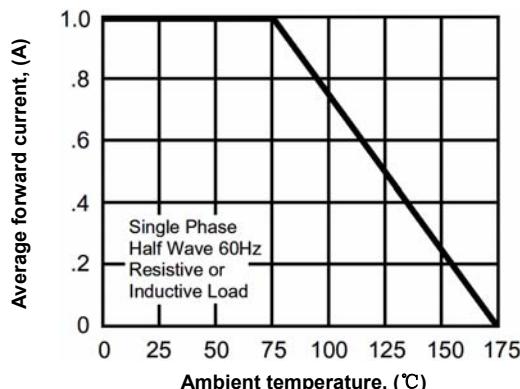
**Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)**

Figure 1. Typical forward current derating curve

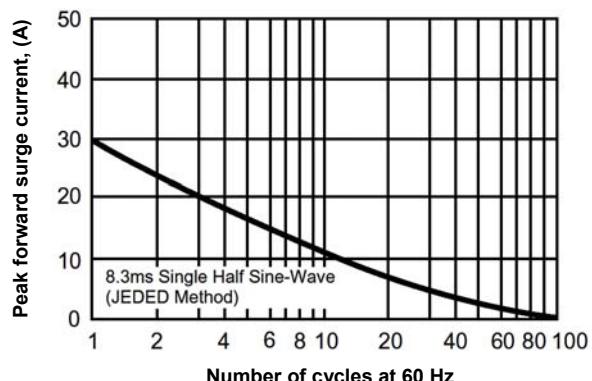


Figure 2. Max. non-repetitive forward surge current

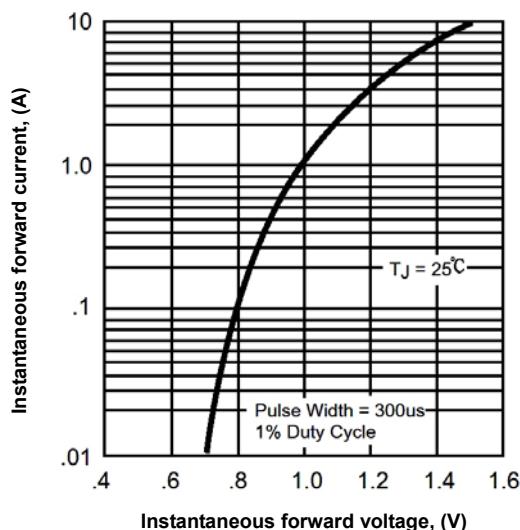


Figure 3. Typical instantaneous forward characteristics

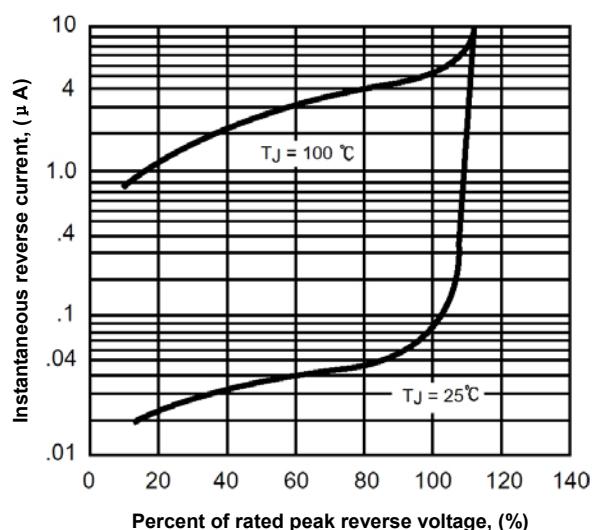


Figure 4. Typical reverse characteristics

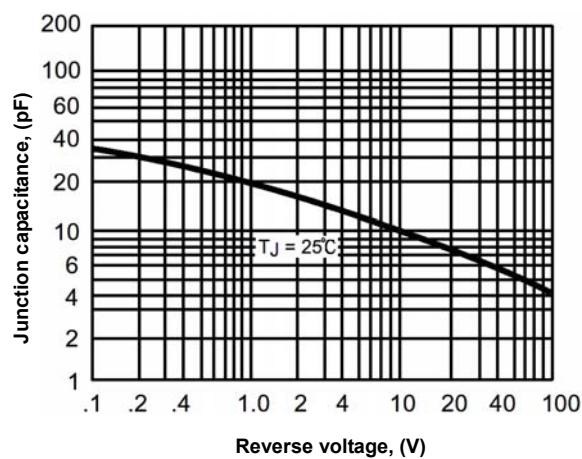
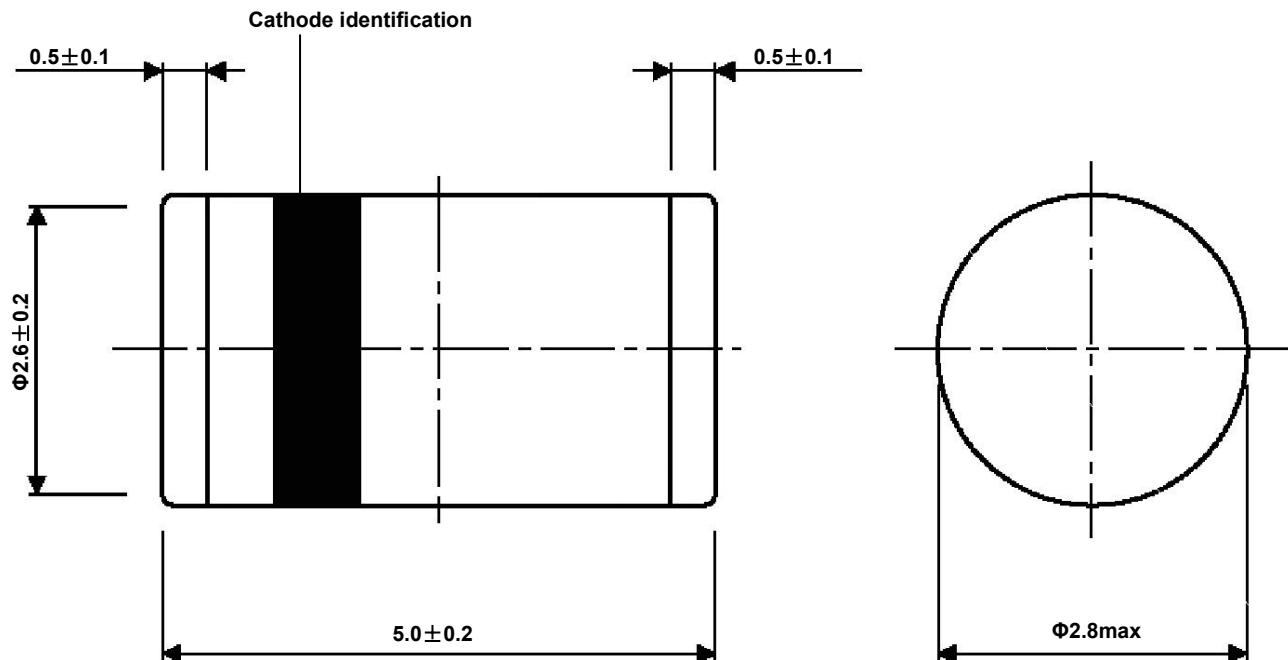


Figure 5. Typical junction capacitance

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Dimensions in mm



MELF

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